

KP1500-POWER THYRISTOR

Shanghai Sunco Electronics Co., Ltd.

1200-1800 V_{DRM}

HIGH POWER THYRISTOR FOR PHASE CONTROL APPLICATIONS

Features:

- . All Diffused Structure
- . Amplifying Gate Configuration
- . Blocking capability up to 1800 volts
- . High dv/dt Capability
- . Pressure Assembled Device

ELECTRICAL CHARACTERISTICS AND RATINGS

Blocking - Off State

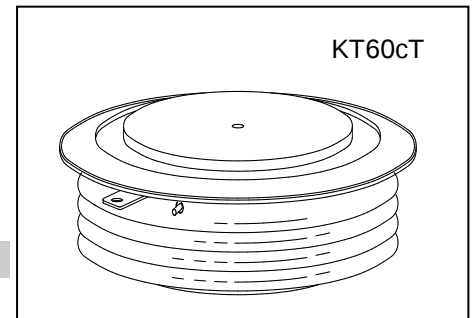
Device Type	V_{RRM} (1)	V_{DRM} (1)	V_{RSM} (1)
KP1500/12	1200	1200	1400
KP1500/14	1400	1400	1600
KP1500/16	1600	1600	1800
KP1500/18	1800	1800	2000

V_{RRM} = Repetitive peak reverse voltage

V_{DRM} = Repetitive peak off state voltage

V_{RSM} = Non repetitive peak reverse voltage (2)

Repetitive peak reverse leakage and off state leakage	I_{RRM}/I_{DRM}	5 mA 90 mA (3)
Critical rate of voltage rise	dv/dt (4)	1000 V/ μ sec



Notes:

- (1) All voltage ratings are specified for an applied 50Hz/60Hz sinusoidal waveform over the temperature range 0 to +125 °C.
- (2) 10 msec. max. pulse width
- (3) Maximum value for $T_j = 125$ °C.
- (4) Minimum value for linear and exponential waveshape to 67% rated V_{DRM} . Gate open. $T_j = 125$ °C.
- (5) The value of di/dt is established in accordance with standard JB/T 8950.2-2013

Conducting - On State

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Average value of on-state current	$I_{T(AV)}$		1500		A	Sinewave, 180° conduction, $T_c = 70$ °C
RMS value of on-state current	I_{TRMS}		2355		A	Nominal value
Peak one cycle surge (non repetitive) current	I_{TSM}		18000		A	10.0 msec (50Hz), sinusoidal wave-shape, 180° conduction, $T_j = 125$ °C
I square t	I^2t		1.6×10^6		A ² s	10 msec
Latching current	I_L		1000		mA	$V_D = 12$ V; $R_L = 12$ ohms
Holding current	I_H		200		mA	$V_D = 12$ V; $I = 2.5$ A
Peak on-state voltage	V_{TM}		1.55		V	$I_{TM} = 3000$ A; $T_j = 25$ °C
Threshold voltage, low-level	V_{TO}		0.91		V	$T_j = 125$ °C
Slope resistance, low-level	r_T		0.3		m Ω	1000A to 3000A
Critical rate of rise of on-state current	di/dt		200		A/ μ s	Repetition

Gating

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Peak gate power dissipation	P_{GM}		20		W	
Average gate power dissipation	$P_{G(AV)}$		4		W	
Gate-trigger current	I_{GT}		200		mA	$V_D = 12\text{ V}; R_L = 3\text{ ohms}; T_j = +25\text{ }^\circ\text{C}$
Gate- trigger voltage	V_{GT}	0.70	2.5		V	$V_D = 12\text{ V}; R_L = 3\text{ ohms}; T_j = +25\text{ }^\circ\text{C}$
Peak negative voltage	V_{GRM}		5		V	

Dynamic

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Delay time	t_d		3.0	2.5	μs	$I_{TM} = 100\text{ A}; V_D = 67\% V_{DRM}$ Gate pulse: $V_G = 30\text{ V}; R_G = 10\text{ ohms};$ $t_r = 0.1\mu\text{s}; t_p = 20\mu\text{s}$
Turn-off time (with $V_R = -5\text{ V}$)	t_q			250	μs	$I_{TM} = 1000\text{ A}; di/dt = -10\text{ A}/\mu\text{s};$ $V_R = 50\text{ V}; dV/dt = 30\text{ V}/\mu\text{s};$ $V_D = 67\% V_{DRM}; T_j = 125^\circ\text{C}$
Reverse recovery charge	Q_{rr}			2000	μC	$I_{TM} = 1000\text{ A}; di/dt = -10\text{ A}/\text{s};$ $V_R = 50\text{ V}; T_j = 125^\circ\text{C}$

THERMAL AND MECHANICAL CHARACTERISTICS AND RATINGS

Parameter	Symbol	Min.	Max.	Typ.	Units	Conditions
Operating temperature	T_j	-40	+125		$^\circ\text{C}$	
Storage temperature	T_{stg}	-40	+140		$^\circ\text{C}$	
Thermal resistance - junction to case	$R_{\theta(j-c)}$		0.018		$^\circ\text{C}/\text{W}$	Double sided cooled
Thermal resistance - case to heatsink	$R_{\theta(c-s)}$		0.005		$^\circ\text{C}/\text{W}$	Double sided cooled
Mounting force	P	24	30	27	kN	
Weight	W			0.593	kg	

* Mounting surfaces smooth, flat and greased

